Indium incorporation and optical properties of polar, semipolar and nonpolar InAIN

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Growth of $In_x Al_{1-x}N$ layers ($0 \le x \le 0.45$) by metal-organic vapour phase epitaxy has been investigated simultaneously on polar (0001), untwinned semipolar ($10\overline{1}3$) and nonpolar ($10\overline{1}0$) AlN templates, which were prepared on planar sapphire substrates. The InN mole fraction (x_{InN}) of the layers was tuned by changing growth temperature from 660° C to 860° C. x_{InN} determined by x-ray diffraction was found to be comparable for the polar, semipolar and nonpolar surface orientations. This is consistent with comparable effective bandgap energy of the layers obtained from optical transmission measurements at room-temperature. The bandgap bowing parameter was found to be strongly composition-dependent. Room-temperature photoluminescence measurements showed impurity transitions for the layers with $x_{InN} \leq 0.2$, while InAlN near-band-edge luminescence was observed for the layers with higher x_{InN} .

I. INTRODUCTION

During the past decades, group III-nitride semiconductors (AlN, GaN, and InN) have attracted much interest because of their applications for light-emitting diodes (LEDs), as well as for high-power and highfrequency electronics. In term of room-temperature bandgap energy $(E_{\rm g})$ ranging from $E_{\rm g}^{\rm InN} = 0.65 \, {\rm eV}^1$ to $E_{\sigma}^{\text{AIN}} = 6.2 \text{ eV}^2$, $\text{In}_x \text{Al}_{1-x} \text{N}$ $(0 \le x \le 1)$ should possibly be a good candidate for both ultra-violet (UV) and visible LEDs. However, growth and properties of highquality InAlN alloys are relatively poorly understood as its growth requires drastically different growth conditions due to the large difference in the lattice parameters, bond length, and thermal stability of AlN and InN³. Therefore, for near-UV and visible LEDs operating at above 365 nm, InGaN quantum wells (QWs) have mainly been used as the active regions 4,5 . For UV LEDs operating at below 365 nm, most groups have been using either Al-GaN QWs⁶ or InAlGaN QWs with very small percentage of In, e.g., less than $5\%^7$. Even though, several groups report high internal quantum efficiency obtained from In-AlN materials, which were estimated either by photoluminescence⁸ or cathodoluminescence⁹ under low excitation conditions, an InAlN/AlGaN-based LED operating at 340-350 nm has only recently been reported¹⁰.

Growth on semipolar and nonpolar planes results in a reduction of built-in fields¹¹, which can increase the radiative recombination efficiency of QWs, as already confirmed for InGaN-based LEDs^{4,12}. However, similar to semipolar^{13–19} and nonpolar AlGaN^{18,20–22}, a few studies have been performed for semipolar $(11\overline{2}2)$ InAlN grown on UV-transparent $(11\overline{2}2)$ AlN/sapphire templates^{23,24}. One of the reasons is the limit of available non-cplane AlN substrates 13,17,21 and templates 25,26 . Additionally, non-c-plane InAlN layers were grown on

quasi-UV-transparent templates and substrates, e.g., semipolar $(10\overline{1}3)$ InAlN on (113) yttria-stabilized cubic zirconia substrates²⁷, nonpolar (10 $\overline{10}$) *m*-plane In-AlN on m-plane GaN substrates⁹ and m-plane ZnO substrates^{28,29}, as well as nonpolar $(11\overline{2}0)$ *a*-plane In-AlN on GaN/sapphire templates³⁰. Among these investigated surface orientations, compositional study has only been done for (0001) vs. $(10\overline{1}0)$ InAlN layers⁹ and (0001) vs. $(11\overline{2}2)$ InAlN layers²⁴. From these studies, no remarkable difference of the InN mole fraction (x_{InN}) has been found for the layers with different surface orientations.

In this paper, we report on indium incorporation and optical properties of InAlN layers grown simultaneously on polar (0001), untwinned semipolar ($10\overline{1}3$) and nonpolar $(10\overline{1}0)$ AlN templates by metal-organic vapour phase epitaxy (MOVPE). Compositional study of these lavers has been investigated by x-ray diffraction and roomtemperature optical transmission measurements.

П. EXPERIMENTAL

Growth was performed in an EpiQuest 3×2 -in. close-coupled showerhead MOVPE reactor. Ammonia (NH_3) , trimethylindium (TMIn) and trimethylaluminium (TMAl) were used as precursors. To prevent residual gallium that may strongly auto-incorporate in InAlN^{31–33}, prior to InAlN epitaxy, the showerhead and chamber inner wall were cleaned to remove residual materials deposited from previous growth experiments. Afterwards, the chamber and susceptor were long-baked at 1300°C, and then coated with about $2-\mu$ m-thich AlN layer at the same temperature.

Differently surface-oriented AlN templates grown on sapphire substrates were used to grow InAlN, including (0001) AlN on *c*-plane sapphire, $(10\overline{1}0)$ AlN and $(10\overline{1}3)$ AlN on *m*-plane sapphire. Growth parameters of the $(10\overline{1}0)$ templates are reported elsewhere²⁶. To pro-

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duce untwinned Al-polar $(10\bar{1}3)$ AlN templates, about 10-nm-thick $(10\bar{1}3)$ AlN layer was initially sputtered onto 2-inch *m*-plane sapphire wafers using directional sputtering^{19,34}. Afterwards, these wafers were loaded into the reactor chamber to grow a 300-nm-thick AlN layer at a surface temperature of 1290°C.

Prior undoped InAlN growth, under a reactor pressure of 2.7 kPa in hydrogen ambient, three differently oriented AlN templates were heated to 1290°C to grow a 100-nm-thick AlN layer with $P_{\rm NH_3} = 6.2$ Pa and $P_{\rm TMAl} = 0.16$ Pa. Afterwards, the reactor temperature was reduced to 660-860°C to grow uncapped InAlN layers with a nominal thickness of 120 nm at a pressure of 10 kPa in nitrogen ambient. This corresponds to a growth rate of ~0.05 nm/s. During InAlN growth, $P_{\rm TMAl} = 0.12$ Pa, $P_{\rm TMIn} = 0.12$ Pa and $P_{\rm NH_3} = 1000$ Pa were used. This corresponds to an In/(In+Al) ratio of 0.5 in gas phase and a V/III of ≈4100.

The crystal orientation and structural properties of the (0001), (1013) and (1010) InAlN samples were characterized using a Malvern Panalytical Empyrean triple-axis high-resolution X-ray diffraction (HR-XRD) system with a CuK_{α 1} source ($\lambda = 1.5406$ Å). Optical transmission measurements of the samples were performed at room temperature (RT) using a Shimadzu UV-2700 UV-Vis spectrometer. For room-temperature photoluminescence (RT-PL) measurements, the samples were excited by two different excitation sources, including a Krypton Fluoride (KrF) excimer (pulsed) laser (ExciStar XS-200) with excitation energy $E_{\rm ex} = 5 \, {\rm eV}$ and an excitation power density ($P_{\rm ex}$) of 5.6 kW/cm², as well as a He-Cd continuous-wave (cw-)laser with $E_{\rm ex} = 3.8 \, {\rm eV}$ and $P_{\rm ex} = 0.05 \, {\rm kW/cm^2}$.

III. RESULTS AND DISCUSSION

A. Phase purity and composition determination

1. Phase purity

Fig. 1 shows wide-range symmetric 2θ - ω XRD scans of four uncapped InAlN layers grown at 660°C and 860°C on *m*-plane AlN and (1013) AlN templates. Besides the (3030) diffraction peak of *m*-plane sapphire at $\approx 68.2^{\circ}$, there are only peaks related to (1010) InAlN/AlN (Fig. 1(a)) and (1013) InAlN/AlN (Fig. 1(b)). This indicates that these layers are indeed single phase. The InAlN peaks clearly appear in the scans of the layers grown at 660°C, while they are almost unobservable for the layers grown at 860°C. This indicates a higher x_{InN} of the layers grown at 660°C. Additionally, positions of six selected diffraction peaks of metallic indium are marked as asterisk symbols (*) in Fig. 1(b), indicating that there is no metallic inclusion in these layers grown at the employed temperatures.

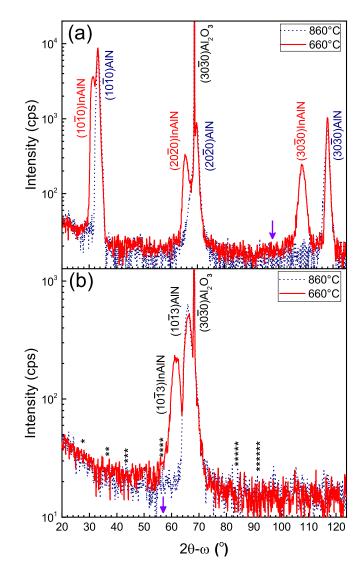


FIG. 1. Symmetric 2θ - ω XRD scans of uncapped InAlN layers simultaneously grown on $(10\bar{1}0)$ AlN (a) and $(10\bar{1}3)$ AlN templates (b) at different temperatures. These scans were performed with an open detector without any receiving slit. Positions of six selected diffraction peaks of metallic In are marked as asterisk symbols (*) such as (100), (002), (111), (112), (203) and (301) In with increasing 2θ angles. The arrows in (a) and (b) indicate positions of the (30 $\bar{3}0$) InN (\approx 98°) and (10 $\bar{1}3$) InN (\approx 57°) diffraction peaks, respectively.

2. Composition determination

Similar to works previously reported for c-plane, mplane and untwinned (1013) AlGaN layers^{18,19,22}, for the differently oriented InAlN layers studied here, their x_{InN} were also calculated from high-resolution 2θ - ω measurements of different symmetric, skew-symmetric and asymmetric InAlN diffraction peaks. Fig. 2 shows the calculated x_{InN} as a function of growth temperature. Similar to previously findings for InAlN^{23,24} and InGaN^{35,36}, x_{InN} of the grown InAlN layers gradually increases with

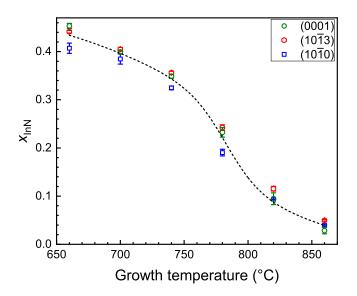


FIG. 2. XRD-calculated x_{InN} of the differently oriented $In_x Al_{1-x}N$ layers as a function of temperature.

decreasing growth temperature, mainly due to the suppression of InN desorption. At each growth temperature, $x_{\rm InN}$ values of the differently oriented layers are quite comparable with $x_{\rm InN}$ of the *m*-plane layers is little bit lower than the others. A maximum difference of $x_{\rm InN}$ is of less than 0.05 for the layers grown at 660°C and 780°C, while it is smaller than 0.03 for the layers grown at the other temperatures.

In general, different research groups employ different growth conditions (e.g., temperature, pressure and V/III ratio) to grow ternary alloys using MOVPE systems. This might result in different material incorporations on different surface orientations. For example, different results of indium incorporation in *c*-plane and *m*-plane In-GaN/GaN have previously been reported, e.g., $c < m^{35,49}$ or $c \approx m^{36}$. So far, there is only one report about compositional study of (1013) InGaN/GaN, showing that this orientation has the lowest indium incorporation among twenty-five different orientations investigated in Ref. 49. However, indium incorporation in InGaN is mostly limited by desorption, which strongly depends on the surface termination and growth efficiency.

For MOVPE-grown AlGaN/AlN, it has recently been reported that aluminium incorporation is comparable on different orientations including *c*-plane, *a*- and *m*-planes, as well as $(10\bar{1}3)$ and $(11\bar{2}2)$ planes^{18–20,22}. For MOVPEgrown InAlN, as aforementioned, comparable $x_{\rm InN}$ values have previously been found for *c*-plane vs. *m*-plane InAlN/GaN layers⁹, and *c*-plane vs. $(11\bar{2}2)$ InAlN/AlN layers²⁴. Additionally, comparable $x_{\rm InN}$ values have been found for N-polar and metal-polar *c*-plane InAlN/GaN⁵⁰. These results suggest that the impact of surface orientation on aluminium incorporation seems to be small or negligible for Al-containing alloys.

As aforementioned, growth parameters are very important for material incorporation. It is well-known that

TABLE I. In-plane strain state in a wurtzite crystal coordinate system with $\boldsymbol{x} \mid\mid [11\overline{2}0], \boldsymbol{z} \mid\mid [0001]$, and $\boldsymbol{c'} \mid\mid [30\overline{3}\overline{2}]$ of the (0001), (10 $\overline{1}3$) and (10 $\overline{1}0$) InAlN/AlN layers grown on AlN templates at different growth temperatures.

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Surface orientations		(0001)	$(10\bar{1}3)$		$(10\bar{1}0)$	
Materials	Growth temp.	ϵ_{xx}	ϵ_{xx}	$\epsilon_{c'}$	ϵ_{xx}	ϵ_{zz}
	(°C)	(10^{-4})	(10^{-4})	(10^{-4})	(10^{-4})	(10^{-4})
AlN	1290	7.8	-11.8	1.4	0.6	-1.8
InAlN	860	-40.5	-16.2	65.0	-1.6	7.4
	820	-76.2	-18.2	54.2	0.7	-3.1
	780	-65.3	-46.8	-20.2	-8.5	40.6
	740	-29.3	10.1	10.8	-4.5	22.4
	700	-30.1	47.4	-0.5	-13.7	59.8
	660	-39.8	21.7	-15.4	-13.6	58.4

parasitic reactions between TMGa, TMIn and NH₃ is much less severe than for TMAl and $NH_3^{51,52}$. Therefore, for Al-containing nitrides, suppressing these reactions is very essential to enhance growth efficiency and aluminium incorporation. Low growth pressures and low V/III ratios are generally used to grow Al- $GaN^{3,14-16,18-20,22,51-53}$ and $InAlN^{8,9,23,24}$. It should be noted that low growth temperatures can also be used to reduce the reaction rate and gallium desorption, leading to an increased AlGaN growth efficiency 18,52,53. For the InAlN layers studied here, the use of low temperatures, low pressure, and low V/III ratio suppressed the TMAI:NH₃ pre-reactions, resulting in the enhanced aluminium incorporation. Consequently, re-evaporation of InN volatile species can be suppressed, resulting in a higher indium incorporation. This also can explain why x_{InN} values of the grown *c*-plane, *m*-plane and (1013) layers are comparable.

Tab. I shows the in-plane strain state of the differently oriented InAlN layers grown on AlN templates at different temperatures. Here, for example, the strain (ϵ_{xx}) along [11 $\overline{2}0$] was calculated as: $\epsilon_{xx} = (a_{\text{measurement}} - a_{\text{relax}})/a_{\text{relax}}$. The strain ϵ_{zz} along [0001] (and $\epsilon_{c'}$ along [30 $\overline{3}\overline{2}$] for the (10 $\overline{1}3$) layers) was calculated using the same manner. In Tab. I, it is clearly seen the anisotropic strain of the (10 $\overline{1}3$) and *m*-plane layers along two inplane directions, e.g., $\epsilon_{xx} \neq \epsilon_{c'}$ obtained for the (10 $\overline{1}3$) layers and $\epsilon_{xx} \neq \epsilon_{zz}$ obtained for the *m*-plane layers.

B. Optical properties

1. Bandgap determination

To investigate optical bandgap of the grown layers, optical transmission measurements were performed at RT. From these measurements, Tauc plots⁵⁴ of $(\alpha h\nu)^2$ versus photon energy $(h\nu)$ have been extracted to estimate absorption edge (i.e., effective energy bandgap $E_{\rm g}^{\rm InAlN}$) of the layers by extrapolating the linear portion from the plots, as shown in Fig. 3(a).

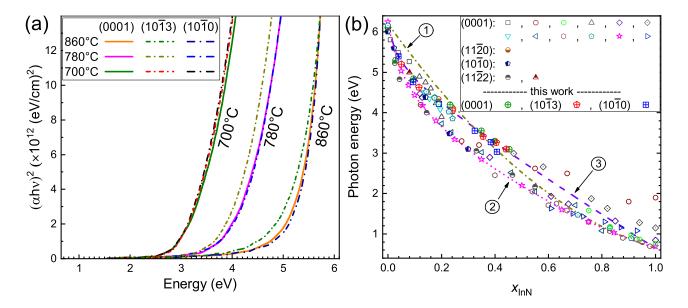


FIG. 3. (a) Tauc plots of the (0001), $(10\overline{1}3)$ and $(10\overline{1}0)$ InAlN co-loaded layers grown at three different temperatures. (b) Effective energy bandgap E_g of the grown layers $[\oplus, \oplus, \boxplus]$ plotted as a function of XRD-calculated x_{InN} . Bandgap data points previously reported for polar (0001) InAlN $[\square^{37}, \bigcirc^{38}, \bigcirc^{39}, \triangle^{40}, \diamondsuit^{41}, \bigotimes^{42}, \bigtriangledown^{43}, \triangleleft^{44}, \bigcirc^{45}, \bigcirc^{46}, \bigstar^{47}, \succ^{48}]$, nonpolar (11 $\overline{2}0$) InAlN $[\square^{30}]$ and (10 $\overline{1}0$) InAlN $[\square^{37}, \bigcirc^{38}, \bigcirc^{39}, \triangle^{40}, \diamondsuit^{41}, \bigotimes^{42}, \bigtriangledown^{43}, \triangleleft^{44}, \bigcirc^{45}, \bigcirc^{46}, \bigstar^{47}, \succ^{48}]$, nonpolar (11 $\overline{2}0$) InAlN $[\square^{30}]$ and (10 $\overline{1}0$) InAlN $[\square^{9}]$, as well as semipolar (11 $\overline{2}2$) InAlN $[\square^{23}, \triangle^{24}]$ are also plotted for comparison. The dash-dot line (1) is a fitting using Eq. 1 with b_x described in Eq. 2 [with $A \neq 0$ and B = C = 0]. The dot line (2) is a fitting to the data points (\bigstar) reported in Ref. 47 using Eq. 1 $[A \neq 0, B \neq 0, C \neq 0]$. The dash line (3) is a fitting to the data points obtained in this study using Eq. 1 $[A \neq 0, B \neq 0, C \neq 0]$.

 $E_{\rm g}^{\rm InAlN}$ values of the differently oriented layers are plotted as a function of XRD-calculated $x_{\rm InN}$ in Fig. 3(b). Their E_{g}^{InAlN} values are comparable, confirming their comparable x_{InN} . Fig. 3(b) also shows bandgap data previously reported for c-plane^{37-42,44-48}, a-plane³⁰, mplane $InAlN^9$, and $(11\overline{2}2)InAlN^{23,24}$. It should be noted that almost these data points were estimated from RT optical measurements (e.g., transmission, reflectance and ellipsometry measurements), except data points of Wang et al.⁴³ and Schulz et al.⁴⁷ were estimated from lowtemperature PL excitation measurements. Given the scattered data points in the literature, the $E_{\sigma}^{\text{InAlN}}$ values of the layers studied here are comparable^{24,30,40,42,43,46} or larger^{9,23,44,45,47}. This might be attributed to different characterization methods and different growth conditions. It should be noted that the effects of in-plane strain of our layers on the shift of $E_{\sigma}^{\text{InAlN}}$ can be neglected, as they only cause a shift of less than $0.05 \,\mathrm{eV}$ estimated for the c-plane layers and less than $0.01 \, \text{eV}$ estimated for the *m*-plane and $(10\overline{1}3)$ layers. More important can be other effects of lateral decomposition due to grainy surface growth for relaxed and/or mismatched layers 9,23,24 . This can lead to a low onset of adsorption in In-rich areas.

2. Bandgap bowing parameter

It is well-known that the effects of composition disorder on the conduction and valence band edges lead to a nonlinear behaviour of $E_{\rm g}$ of nitride alloys versus group-III composition⁵⁵. Therefore, a bandgap bowing parameter (b_x) is commonly used to determine this behaviour. This has previously reported for AlGaN^{18,19,22,39,41} and In-AlN^{37-43,45-48}. For In_xAl_{1-x}N, the dependence of $E_{\rm g}^{\rm InAlN}$ on $x_{\rm InN}$ is commonly described by the relation:

$$E_{g}^{InAlN} = x \cdot E_{g}^{AlN} + (1-x) \cdot E_{g}^{InN} - b_{x} \cdot x \cdot (1-x), \quad (1)$$

where

$$b_x = \frac{A}{1 + B \cdot x + C \cdot x^2}.$$
(2)

Here, A, B and C are adjustable parameters of the fit.

For InGaN^{39,41} and AlGaN^{18,19,22,39,41}, most groups do a fit with a composition-*independent* $b_x = b_0$, i.e., $A \neq 0$ and B = C = 0. This case has also been used to fit for InAlN layers^{37,40,45,48}. For the InAlN layers studied here, the shift of $E_{\rm g}^{\rm InAlN}$ vs. $x_{\rm InN}$ can also be fitted using Eq. 1 with b_0 , which results in a bowing parameter of $(4.0\pm0.4) \, {\rm eV}$, as shown as the fitted line #1 in Fig. 3(b). For this fitting, values of $E_{\rm g}^{\rm InN} = 0.65 \, {\rm eV}^1$ and $E_{\rm g}^{\rm AlN} = 6.2 \, {\rm eV}^2$ have been fixed. Even though, this bowing value is in good agreement with values of about 4.0-5.0 eV previously reported for *c*-plane InAlN^{37,39,40,43,45,48}, this fitting does not satisfy the data points in the $x_{\rm InN} < 0.2$ regime. Compared to composition-independent fittings of InGaN $(b_0 \approx 1.4 \text{ eV}^{39})$ and AlGaN $(b_0 \approx 0.9$ - $1.0 \text{ eV}^{18,19,22,39,41})$, the bowing value of InAlN is much larger. Based on results obtained for InAlN layers with $x_{\text{InN}} \geq 0.4$, Jones *et al.*⁴⁵ have attributed this large value to band-filling effects, which might blue-shift the absorption edge of In-rich layers, and a stronger non-parabolic conduction band than valence band with decreasing x_{InN} .

Several groups have used a composition-dependent b_x to achieve a good fit of $E_{\rm g}^{\rm InAlN}$ across investigated $x_{\rm InN}^{41,44,46}$. Two different cases $[A \neq 0, B \neq 0, C = 0]^{41,44}$ and $[A \neq 0, B = 0, C \neq 0]^{46}$ have previously been used, which might be attributed to different $E_{\rm g}^{\rm InAlN}$ achieved at those different groups. It has recently been reported that cation-related localized states strongly perturb the InAlN band structure, leading to a strong bandgap bowing at the low- $x_{\rm InN}$ regime^{47,56}. This has evidently been clarified by a combined experimental and theoretical study of $E_{\rm g}^{\rm InAlN}$ across the entire range of $x_{\rm InN}$ of *c*-plane In-AlN/GaN layers⁴⁷. Similar to the work of Jones *et al.*⁴⁵, a stronger non-parabolic conduction band than valence band has also been reported⁴⁷.

By fitting the data points of Schulz *et al.*⁴⁷ (\bigstar in Fig. 3(b)) using Eqs. 1 and 2, we have found that using a case of $[A \neq 0, B \neq 0, C \neq 0]$ gives the best fitting (the coefficient of determination *R*-squared = 0.9999), as shown as the fitted line #2 in Fig. 3(b). *A*, *B*, and *C* values are found to be $(29.6\pm0.1) \text{ eV}$, $(12.5\pm0.0) \text{ eV}$ and $(-5.0\pm0.0) \text{ eV}$, respectively. (It should be noted that $E_{\text{g}}^{\text{InN}} = 0.65 \text{ eV}$ and $E_{\text{g}}^{\text{AIN}} = 6.2 \text{ eV}$ have also been fixed for this fitting). For the InAlN layers studied here, the shift of $E_{\text{g}}^{\text{InAlN}}$ vs. x_{InN} can also be fitted using the same manner. Here, to compare with values obtained from the fitted line #2 and to achieve the best fitting, *A* and *C* values were fixed to be of 29.6 eV and -5.0 eV, respectively. This also results in the best fitting (*R*-squared = 0.9940) with a *B* value of $(24.2\pm0.9) \text{ eV}$, as shown as the fitted line #3 in Fig. 3(b).

3. Photoluminescence

For MOVPE-grown InAlN layers, a large Stokes-shift of up to 1 eV between bandgap energy and PL peak emission energy ($E_{\rm PL}$) has previously been reported for c-plane⁴³, a-plane³⁰, m-plane⁹ and (11 $\bar{2}2$) layers²⁴ with $x_{\rm InN} \leq 0.3$. This indicates large alloy fluctuations in those layers, which have been attributed to grainy morphology. This also somehow makes determination of InAlN nearband-edge (NBE) luminescence difficult if the NBE is close to impurity-related transitions of (Al,Ga)N underlayers^{9,57-61}.

For AlGaN grown on sapphire, deep impurity transitions involving isolated cation vacancy with threenegative charges $V_{\rm III}^{3-}$, cation vacancy complex with onenegative charges $(V_{\rm III}\text{-}\mathrm{complex})^{1-}$ (e.g., $(V_{\rm III}\text{-}\mathrm{O_N})^{1-}$), and cation vacancy complex with two-negative charges

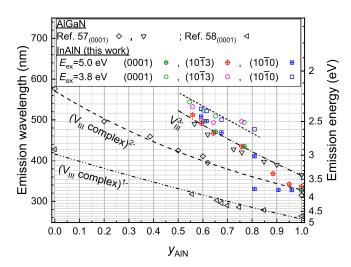


FIG. 4. RT-PL peak emission energy measured with the KrF excimer laser ($E_{\rm ex} = 5.0 \, {\rm eV}$) [\oplus , \oplus , \boxplus] and the He-Cd cw-laser ($E_{\rm ex} = 3.8 \, {\rm eV}$) [\bigcirc , \bigcirc , \Box] of the grown the (0001), (1013) and (1010) InAlN co-loaded layers plotted as a function of the AlN mole fraction ($y_{\rm AlN} = 1 - x_{\rm InN}$). RT-PL peak emission energies of $V_{\rm III}^{3-}$ and their complexes of *c*-plane AlGaN layers reported in Refs. 57 and 58 are also plotted for comparison. Lines are guide to the eye.

 $(V_{\rm III}\text{-}{\rm complex})^{2\text{-}}$ (e.g., $(V_{\rm III}\text{-}{\rm O_N})^{2\text{-}}$) have previously been studied by RT-PL for layers with different surface orientations including c-plane^{16,57,58,62} and $(11\bar{2}2)^{15,16}$. The energy formation of cation vacancies and vacancy complexes has been found to follow the order⁵⁸: $V_{\rm III}^{3-} < (V_{\rm III}\text{-}{\rm complex})^{2\text{-}} < (V_{\rm III}\text{-}{\rm complex})^{1\text{-}}$. Fig. 4 shows these impurity transitions obtained for c-plane AlGaN plotted as a function of the AlN mole fraction $(y_{\rm AlN})$. (Impurity transitions of $(11\bar{2}2)$ AlGaN can be seen in Ref. 16.) It has been found that the formation of $V_{\rm III}^{3-}$ is more favourable in the $y_{\rm AlN} \leq 0.5$ regime^{16,57}, while $(V_{\rm III}\text{-}{\rm complex})^{2\text{-}}$ can be formed in the whole range^{16,57}. Additionally, $(V_{\rm III}\text{-}{\rm complex})^{1\text{-}}$ has been found to form in the $y_{\rm AlN} \geq 0.4$ regime^{16,58}.

Additionally, $E_{\rm PL}$ at around 3.6-3.8 eV of bulk AlN crystals has also been assigned to originate from substitutional carbon on nitrogen site $(C_{\rm N})^{59,60}$. A higher carbon concentration (e.g., $[C] \approx 2 \times 10^{17} \rightarrow 2 \times 10^{19} \, {\rm cm}^{-3}$) in AlN not only shifts the C_N-related $E_{\rm PL}$ to larger energy region but also lowers the $E_{\rm PL}$ intensity. The latter has been attributed to an insufficiency of carbon to act as the main acceptor⁵⁹. It has also been reported that a donoracceptor-pair (DAP) involving C_N (e.g., $[C] \ge 10^{18} \, {\rm cm}^{-3}$) and nitrogen vacancy (V_N) corresponds to an $E_{\rm PL}$ at 2.8 eV⁶⁰. This DAP intensity was found to increase with increasing [C].

For the grown InAlN layers here, RT-PL measurements were also performed ($E_{\rm ex} = 5.0 \, {\rm eV}$). Fig. 5 exemplifies PL spectra of the *m*-plane InAlN layers grown at different temperatures on *m*-plane AlN templates. (The *c*-plane and ($10\bar{1}3$) co-loaded layers also have almost the same spectra, except the fact that the *c*-plane layers grown

at 660°C and 780-860°C do not emit light.) Spectra of the m-plane templates show only one UV band with an $E_{\rm PL}$ at about 3.8 eV and a full-width of half maximum $(\Delta_{\rm PL})$ of about 0.39 eV (after a Gaussian fitting of the corresponding band). For the layers grown at 780-860°C, their spectra also show an $E_{\rm PL}$ at almost the same position as obtained for the templates, irrespective of different x_{InN} ($\Delta_{\text{PL}} \approx 0.38 - 0.4 \,\text{eV}$). This peak intensity decreases with decreasing InAlN growth temperature, e.g., a factor of nine between the layers grown at 860°C and 780°C (a factor of twelve compared with the AlN peak intensity). To compare with the impurityrelated transitions obtained for AlGaN, $E_{\rm PL}$ values of these investigated InAlN layers are also plotted as a function of $y_{AIN} = 1 - x_{AIN}$, as shown in Fig. 4. E_{PL} values of these layers do not nicely match the $(V_{\rm III}\text{-complex})^{2-}$ line, thus this impurity transition can not be considered as the main cause. According to results previously reported for bulk AlN crystals⁵⁹, the dominant $E_{\rm PL}$ value at $\sim 3.8 \,\mathrm{eV}$ of the InAlN layers can be mainly attributed to the effects of C_N . This is plausible as [C] should be higher in these layers grown at lower growth tempera $tures^{63}$. This is a reason why the peak intensity of this C_N-related transition decreases with decreasing growth temperature. However, no DAP emission at 2.8 eV has been observed.

Besides the dominant UV band at 3.8 eV, the spectrum of the *m*-plane layer grown at 780°C also shows a very weak band (just above the noise level) with $E_{\rm PL}$ at about 3.0 eV. For the layers grown at below 780°C, the UV band completely disappears, instead of that, visible bands with $E_{\rm PL} = 2.4 - 2.7$ eV appear ($\Delta_{\rm PL} \approx 0.3 - 0.5$ eV). At lower growth temperatures, the O_N and C_N concentrations in the layers should be higher due to lower decomposition rates of NH₃. This should lead to an appearance of O_N- and C_N-related transitions. However, $E_{\rm PL}$ values of the layers grown at 660-780°C only match the $V_{\rm III}^{3-}$ line.

Even though, for AlN layers grown by NH₃-source molecular beam epitaxy (MBE)⁶⁴ it has been found that the density of $V_{\rm Al}^{3-}$ increases with decreasing growth temperature, MBE has completely different growth kinetics from MOVPE. A limited study on the effects of growth temperature at 1150°C and 1200°C on $V_{\rm Al}^{3-}$ related defects in MOVPE-grown AlN layers has shown that the $V_{\rm Al}^{3-}$ concentration is lower at the lower temperature⁶⁵. Additionally, a previous study on the effects of relatively low growth temperatures at 540°C and 800°C on growth efficiency of MOVPE-grown AlN suggests that the lower temperature can reduce TMAl:NH₃ pre-reactions⁵³. Both these results are plausible due to the fact that the formation of the pre-reactions strongly depends on temperature⁵². Therefore, for the InAlN layers grown at 660 - 740°C studied here, we can exclude the effects of $V_{\rm HI}^{3-}$ as the main cause for their $E_{\rm PL}$ values.

As visible $E_{\rm PL}$ vs. corresponding $x_{\rm InN}$ of the In-AlN layers grown at 660-780°C closes their $E_{\rm g}^{\rm InAlN}$ vs. $x_{\rm InN}$ shown in Fig. 3(b), we attribute them to InAlN

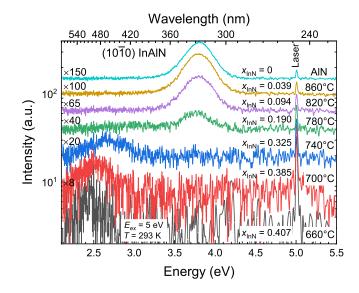


FIG. 5. RT-PL spectra measured with the KrF excimer laser $(E_{\rm ex} = 5.0 \,\mathrm{eV})$ of the *m*-plane InAlN layers grown at different temperatures on *m*-plane AlN templates.

NBE luminescence. The NBE peak intensity is weak, which might suggest that one state of the O_N - and C_N -related transitions still exists in the NBE. Due to the bandgap shrinking, these non-radiative channels become even stronger.

To confirm the InAlN NBE, RT-PL of these layers were also measured using the He-Cd laser ($E_{\rm ex} = 3.8 \, {\rm eV}$). (The layers grown at 820°C and 860°C do not emit light while being excited by this laser.) From their spectra (not shown), $E_{\rm PL}$ was also estimated using a Gaussian fitting ($\Delta_{\rm PL} \approx 0.3 - 0.5 \, {\rm eV}$) and plotted in Fig. 4. This $E_{\rm PL}$ also decreases with decreasing $y_{\rm AIN}$ (increasing $x_{\rm InN}$), however, it shifts about $0.1 - 0.2 \, {\rm eV}$ to the lower energy region compared to the data points measured using the KrF laser. This is attributed to the stronger $P_{\rm ex}$ of the KrF laser than that of the He-Cd laser. A Stokes-shift of $0.6 - 0.9 \, {\rm eV}$ has been estimated for these layers (based on $E_{\rm PL}$ using the KrF laser). This shift is comparable with values previously reported for differently oriented InAlN layers^{9,24,30,43}.

IV. CONCLUSIONS

MOVPE-growth of $\ln_x Al_{1x} N$ layers $(0 \le x_{InN} \le 0.45)$ simultaneously on polar (0001) AlN, untwinned semipolar (1013) AlN and nonpolar (1010) AlN templates was investigated. XRD-estimated x_{InN} values of all the coloaded layers were found to be comparable. This is consistent with optical bandgap energy (E_g^{InAIN}) obtained from transmission measurements. An empirical relationship between E_g^{InAIN} with x_{InN} was derived. The bandgap bowing parameter was found to be strongly composition-dependent. RT-PL measurements showed impurity transitions (e.g., $(V_{III}-O_N)^{2^-}$ and C_N) for the layers with $x_{\text{InN}} \leq 0.2$, while InAlN NBE luminescence was observed for the layers with higher x_{InN} .

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